

#### 2.6 GHz SMALL MICROWAVE RELAYS

## RE RELAYS (ARE)

### FEATURES

#### • Excellent high frequency

## characteristics (to 2.6GHz) Type Frequency 900MHz 2.6GHz

Type	ricquericy	500101112	2.00112
WW	V.S.W.R. (Max.)	1.3	1.7
Imped- ance 50Ω	Insertion loss (dB, Max.)	0.2	0.7
	Isolation (dB, Min.)	60	30
Imped- ance 75Ω	V.S.W.R. (Max.)	1.2	1.5
	Insertion loss (dB, Max.)	0.2	0.5
1 322	Isolation (dB, Min.)	60	30
		- 1111-	

Surface-mount type also available

Compact and slim size

Size:  $20.2(L) \times 11.2(W) \times 8.9(H)^*$  mm .795(L)  $\times$  .441(W)  $\times$  .350(H) inch \*Surface-mount terminal is 9.6 mm .378 inch size.

## **TYPICAL APPLICATIONS**

- 1. Broadcasting and video markets.
- Digital broadcasting market
- STB/tuner market, etc.
- 2. Communications market
- Antennae switching
- All types of wireless devices

RoHS Directive compatibility information http://www.nais-e.com/

## SPECIFICATIONS

Arrangement		1 Form C			
Contact materia	ıl	Gold			
Initial contact re (By voltage drop		Max. 100mΩ			
	Contact	rating	1W (at 2.6 GHz [Impedance 75 $Ω$ , V.S.W.R. Max.1.5] [Impedance 50 $Ω$ , V.S.W.R. Max.1.7]) 10mA 24V DC (resistive load)		
Rating	Contact	carrying power	10W (at 2.6GHz [Impedance 75 Ω, V.S.W.R. Max.1.5] [Impedance 50 Ω, V.S.W.R. Max.1.7])		
	Max. swi	itching voltage	30 V DC		
	Max. swi	tching current	0.5 A DC		
High frequency characteristics (Impedance 75Ω) (Initial)	V.S.W.R		Max. 1.2 (to 900MHz) Max. 1.5 (to 2.6GHz)		
	Insertior	loss	Max. 0.2dB (to 900MHz) Max. 0.5dB (to 2.6GHz)		
	Isolation		Min. 60dB (to 900MHz) Min. 30dB (to 2.6GHz)		
High frequency	V.S.W.R		Max. 1.3 (to 900MHz) Max. 1.7 (to 2.6GHz)		
characteristics (Impedance 50Ω) (Initial)	Insertior	ı loss	Max. 0.2dB (to 900MHz) Max. 0.7dB (to 2.6GHz)		
	Isolation		Min. 60dB (to 900MHz) Min. 30dB (to 2.6GHz)		
	Mechani	ical (at 180 cpm)	106		
Expected life (min. operations)	Electri- cal	1W, 2.6GHz, [Impedance 75 $\Omega$ , V.S.W.R. $\leq$ 1.5] [Impedance 50 $\Omega$ , V.S.W.R. $\leq$ 1.7]	3×10⁵		
		10mA 24V DC (resistive load) (at 20cpm)	3×10⁵		

#### Coil (at 20°C, 68°F)

Nominal ope	erating power	T		200 mW		
Characteri	stics					
Initial insulat	tion resistance	Min. 100 MΩ (at 500 V DC				
	Between open contacts			500 Vrms		
Initial breakdown	Between cor	ntact	and coil	1,000 Vrms		
voltage*2	Between contact and ground terminal			500 Vrms		
Operate time	e*3 (at 20°C)	Max. 10ms				
Release tim	e (without dioc	Max. 5ms				
Temperature	e rise (at 20°C)	Max. 60°C				
Shock resistance		Functional*5		Min. 500 m/s <sup>2</sup> {50 G}		
		Destructive*6		Min. 1,000 m/s <sup>2</sup> {100 G}		
Vibration resistance		Functional*7		10 to 55 Hz at double amplitude of 3 mm		
		Destructive		10 to 55 Hz at double amplitude of 5 mm		
Conditions for operation, transport and storage <sup>*8</sup> (Not freezing and condensing at low temperature)			Ambient temp.	<b>−40°C to 70°C</b> −40°F to 158°F		
			Humidity	5 to 85% R.H.		
Unit weight				Approx. 5 g .18 oz		

#### Remarks

\* Specifications will vary with foreign standards certification ratings.

\*1 Measurement at same location as "Initial breakdown voltage" section.

\*2 Detection current: 10mA

<sup>\*3</sup> Nominal operating voltage applied to the coil, excluding contact bounce time. <sup>\*4</sup> By resistive method, nominal voltage applied to the coil: Contact carrying power: 10W, at 2.6GHz, [Impedance 75Ω, V.S.W.R. ≦ 1.5] [Impedance 50Ω, V.S.W.R. ≦ 17]

1.7]
 \*5 Half-wave pulse of sine wave: 11ms, detection time: 10µs.

\*6 Half-wave pulse of sine wave: 6ms

\*7 Detection time: 10µs

\*8 Refer to 5. Conditions for operation, transport and storage conditions in NOTES



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## RE (ARE)

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Contact arrangement 1: 1 Form C	Operating function         0: Single side stable type (Impedance 50Ω)         3: Single side stable type (Impedance 75Ω)	Terminal shape Nil: Standard PC board terminal A: Surface-mount terminal	Coil voltage (DC) 03: 3 V 4H: 4.5 V 06: 6 V 09: 9 V 12: 12 V 24: 24 V	Packing style Nil: Carton packing (Standard PC board terminal only Tube packing (Surface-mount terminal only) Z: Tape and reel packing (picked from 12/13/14 pin side)		

Note: Tape and reel packing symbol "-Z" is not marked on the relay.

"X type tape and reel packing (picked from 8/9/10/11/12/13/14-pin side) is also available. Suffix "X" instead of "Z".

## TYPES AND COIL DATA (at 20°C 68°F)

• Single side stable type (Impedance 50Ω)

• Packing of standard PC board terminal: 50 pcs. in an inner package (carton); 500 pcs. in an outer package.

• Packing of surface-mount terminal: 25 pcs. in an inner package (tube); 200 pcs. in an outer package.

• Packing of surface-mount terminal: 400 pcs. in an inner package (tape and reel); 800 pcs. in an outer package.

Standard PC board terminal	Surface-mount terminal	Nominal voltage, V DC	Pick-up voltage, V DC (max.) (initial)	Drop-out voltage, V DC (min.)(initial)	Coil resistance, $\Omega$ (±10%)	Nominal operating current, mA (±10%)	Nominal operating power, mW	Max. allowable voltage, V DC (at 60°C)
ARE1003	ARE10A03	3	2.25	0.3	45	66.7	200	3.3
ARE104H	ARE10A4H	4.5	3.375	0.45	101	44.4	200	4.95
ARE1006	ARE10A06	6	4.5	0.6	180	33.3	200	6.6
ARE1009	ARE10A09	9	6.75	0.9	405	22.2	200	9.9
ARE1012	ARE10A12	12	9 0	1.2	720	16.7	200	13.2
ARE1024	ARE10A24	24	18	2.4	2,880	8.3	200	26.4

• Single side stable type (Impedance  $75\Omega$ )

• Packing of standard PC board terminal: 50 pcs. in an inner package (carton); 500 pcs. in an outer package.

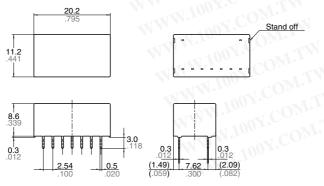
• Packing of surface-mount terminal: 25 pcs. in an inner package (tube); 200 pcs. in an outer package.

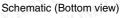
• Packing of surface-mount terminal: 400 pcs. in an inner package (tape and reel); 800 pcs. in an outer package.

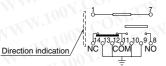
Standard PC board terminal	Surface-mount terminal	Nominal voltage, V DC	Pick-up voltage, V DC (max.) (initial)	Drop-out voltage, V DC (min.)(initial)	Coil resistance, $\Omega$ (±10%)	Nominal operating current, mA (±10%)	Nominal operating power, mW	Max. allowable voltage, V DC (at 60°C)
ARE1303	ARE13A03	3	2.25	0.3	45	66.7	200	3.3
ARE134H	ARE13A4H	4.5	3.375	0.45	101	44.4	200	4.95
ARE1306	ARE13A06	6	4.5	0.6	180	33.3	200	6.6
ARE1309	ARE13A09	9	6.75	0.9	405	22.2	200	9.9
ARE1312	ARE13A12	12	9	1.2	720	16.7	200	13.2
ARE1324	ARE13A24	24	18	2.4	2,880	8.3	200	26.4

### DIMENSIONS

1. Standard PC board terminal (75 $\Omega$ , 50 $\Omega$  type)







mm inch

(Deenergized condition)



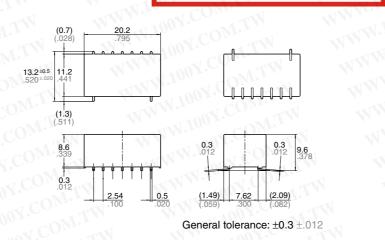
2. Surface mount terminal • 75Ω type

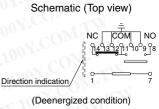
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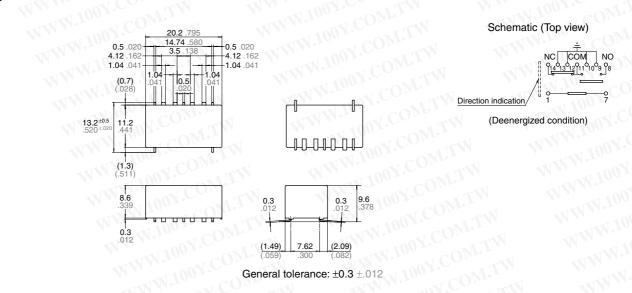
## RE (ARE)

mm inch





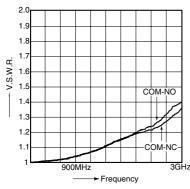
• 50Ω type



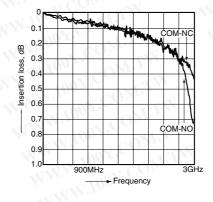
#### **REFERENCE DATA**

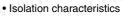
1-(1). High frequency characteristics (Impedance  $75\Omega$ ) (Standard PC board terminal)

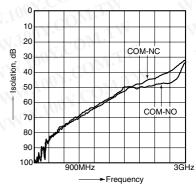
#### • V.S.W.R. characteristics



#### • Insertion loss characteristics



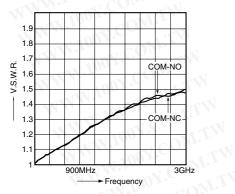




# RE (ARE)

1-(2). High frequency characteristics (Impedance  $50\Omega$ ) (Standard PC board terminal)

#### • V.S.W.R. characteristics



#### NOTES

1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%. However, check it with the actual circuit

since the characteristics may be slightly different.

#### 2. Cleaning

For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick. It is recommended that alcoholic solvents be used.

#### 3. Soldering

1) The manual soldering shall be performed under following condition. Max. 260°C 500°F 10s Max. 350°C 662°F 3s

The affect of the PCB on the relay will differ depending on the type of PCB used. Please verify the type of PCB to be used.

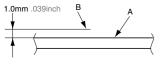
Preheat according to the following conditions.

Temperature	120°C 248°F or less
Time	Within 2 minute

Soldering should be done at  $260\pm5^{\circ}C$   $500\pm5^{\circ}F$  within 6 s.

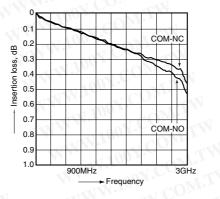
2) In case of automatic soldering, the following conditions should be observed (Surface-mount terminal)

(1) Position of measuring temperature



A: Surface of PC board where relay is mounted B: Above the PC board surface.

Insertion loss characteristics



(2) IR (infrared reflow) soldering method

t2 t3 t4 t5

Temperature rise of relay itself may vary

Therefore, please set the temperature of

soldering portion of relay terminal and

the top surface of the relay case not to

exceed the above mentioned soldering

temperature rise of each portion under

actual mounting condition before use.

Relay 20.0

Tape coming out direction

2) Dimensions of plastic reel

13.85

dia

44.4±8

Max. 50.5

10.6:83

It is recommended to check the

according to the mounting level or the

heating method of reflow equipment.

t2 - t1 = 80 to 120 s

t5 - t3 = 30 to 40 s

t4 = 170 to 190 s

t۱

T1=150°C 302°F

T2=160°C 320°F

T3=183°C 361°F

T4=245°C 473°F

T5=270°C 518°F

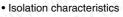
condition.

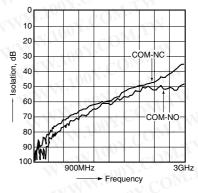
4. Packing style

Relay polarity ba

1) Tape dimensions

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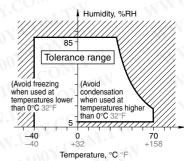




## 5. Conditions for operation, transport and storage conditions

 Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:
 Temperature:

-40 to +70°C -40 to +158°F
(2) Humidity: 5 to 85% RH
(Avoid freezing and condensation.) The humidity range varies with the temperature. Use within the range indicated in the graph below.
(3) Atmospheric pressure: 86 to 106 kPa Temperature and humidity range for usage, transport, and storage:



#### 2) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation. 3) Freezing

Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags. 4) Low temperature, low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.